

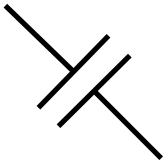
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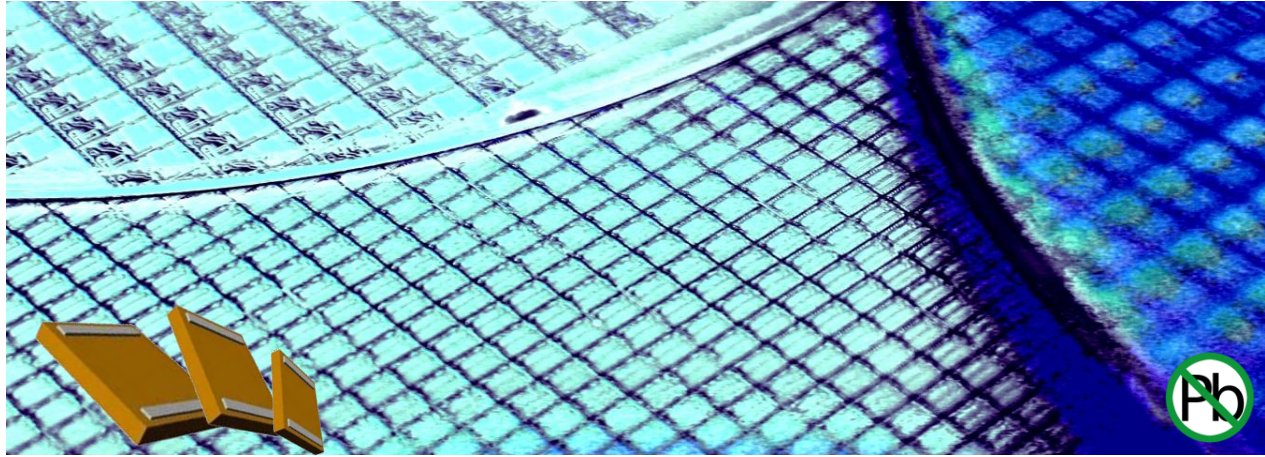
[IPDiA](#)  
[935121427710](#)

For any questions, you can email us directly:  
[sales@integrated-circuit.com](mailto:sales@integrated-circuit.com)



## LPSC427.xxx - 1206 Low Profile Silicon Capacitor

Rev 3.1



### Key features

- Ultra low profile (100µm)
- High stability of capacitance value:
  - ◆ Temperature  $\leq \pm 0.5\%$  (-55°C to +150°C)
  - ◆ Voltage  $< 0.1\%$ /Volts
  - ◆ Negligible capacitance loss through ageing
- Unique high capacitance in 1206 package size, up to 1 µF
- High reliability (FIT  $< 0.017$  parts / billion hours)
- Low leakage current down to 100 pA
- Low ESL and Low ESR
- Suitable for lead free reflow-soldering \*Please refer to our assembly Application Note for further recommendations

Thanks to the unique IPDiA Silicon capacitor technology, most of the problems encountered in demanding applications can be solved.

Low Profile Silicon Capacitors are available with **thicknesses down to 80µm** and are the most appropriate solution in applications with height constraints.

LPSC is the perfect choice for embedded technologies, modules, systems in package, when designers are looking at **utmost decoupling behaviours**.

The Silicon capacitor technology offers a capacitor integration capability (up to 250nF/mm<sup>3</sup>) which allows **downsizing** compared to Tantalum and MLCC.

### Key applications

- All demanding applications, such as medical, telecom, computer industries
- Decoupling / Filtering / Charge pump (i.e.: Pacemakers / mobile phones)
- High reliability applications
- Devices with battery operations
- Extreme miniaturization
- Suitable for Embedded technologies

The IPDiA technology features **high reliability**, up to 10 times better than alternative capacitor technologies, such as Tantalum or MLCC, and eliminates cracking phenomena.

Silicon Capacitor technology also offers a very stable capacitor value over the full operating voltage & temperature range, with a high and stable insulation resistance.

This Silicon based technology is RoHS compliant and compatible with lead free reflow soldering process.

## Electrical specification

		Capacitance value					
		10	15	22	33	47	68
Unit	1 nF	10nF 935.121.427.510	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales
	10 nF	100nF 935.121.427.610	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales	Contact IPDIA Sales
	0,1 µF	1µF 935.121.427.710					
	1 µF						

(\*) 80 µm thickness on request

(\*\*) Extended temperature range (up to +250 °C) available, see Xtreme Temperature Silicon Capacitor product: XTSC

(\*\*\*) Other values on request.

Parameters	Value
Capacitance range	10 nF to 1µF <sup>(***)</sup>
Capacitance tolerances	±15 % <sup>(***)</sup>
Operating temperature range	-55 °C to 150 °C <sup>(**)</sup>
Storage temperatures	-70 °C to 165 °C
Temperature coefficient	<±0.5 %, from -55 °C to +150 °C
Breakdown voltage (BV)	11 VDC <sup>(***)</sup>
Capacitance variation versus RVDC	0.1 % /V (from 0 V to RVDC)
Equivalent Serial Inductor (ESL)	Max 1nH
Equivalent Serial Resistor (ESR)	Max 500mΩ <sup>(***)</sup>
Insulation resistance	100GΩ min @ 3V, 25°C
Ageing	Negligible, < 0.001 % / 1000 h
Reliability	FIT<0.017 parts / billion hours.
Capacitor height	Max 100 µm <sup>(*)</sup>

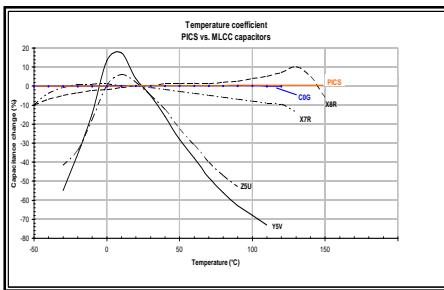


Fig.1 Capacitance change versus temperature variation compared with alternative dielectrics

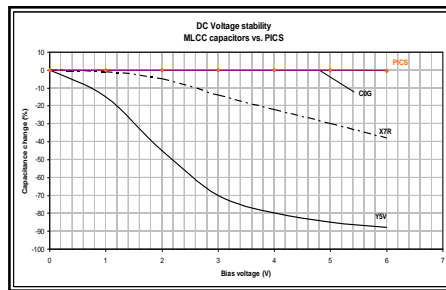


Fig.2 Capacitance change versus voltage variation compared with alternative dielectrics

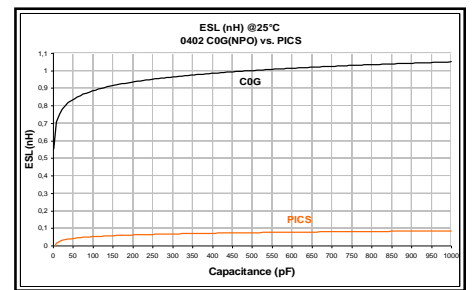


Fig.3 ESL versus capacitance value compared with alternative dielectrics

## Part Number

**935.121.**

**B.2**  
 Breakdown Voltage  
 4 = 11V

**S.**  
 Size  
 7 = 1206

**U**  
 Unit  
 0 = 10 f    5 = 1 n  
 1 = 0.1 p    6 = 10 n  
 2 = 1 p    7 = 0.1 µ  
 3 = 10 p    8 = 1 µ  
 4 = 0.1 n    9 = 10 µ

**XX** → Value (E6)  
 10  
 15  
 22  
 33  
 47  
 68

i.e.: 1 µF/1206 case (LPSC type)  
 → 935.121.427.710

## Termination and Outline

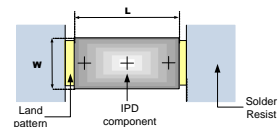
### Termination

Lead-free nickel/solder coating compatible with automatic soldering technologies: reflow and manual.

Typical dimensions, all dimensions in mm.

### Package outline

Typ.		1206
Comp. size	L	3.40±0.05
	W	1.80±0.05



(1206 PCB footprint)

## Packaging

Tape and reel, tray, waffle pack or wafer delivery.

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